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In recent years, with new mechatronic concepts continuously introduced, such as wearable and soft mechatronics devices, there is a great demands of mechatronics education. And being the backstage hero, with the popularization of robotics and 3D printing, mechatronics research will become more and more active.

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**Call for Papers**

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**Topics**

The topics covered in the conference will include, but not be limited to, the following:

- Actuator and smart materials based driving technology
- Aeronautical mechatronics
- Agricultural mechatronics
- Applied robotics including those manipulative, mobile, walking, flying, humanoid and bio-inspired
- Artificial and computational intelligence
- Medical mechatronics and robotic rehabilitation systems
- Wearable assistive devices
- Surgical robots
- Intelligent aids for the elderly and disabled
- Intelligent control and automation
- Machine vision
- MEMS and nano mechatronic technology
- Sensors, sensor fusion & sensor networks
- Underwater mechatronics
- Remote assistance and virtual-reality
- 3D printing technologies

Special sessions on the topics of: Mechatronics in agriculture, Biomechatronics, medical mechatronics & robotics, mechatronics for rehabilitation, wearable mechatronics, wearable exoskeletons for the elders and disables, soft mechatronic systems, mechatronics educations, mechatronics in 3D printing, etc. are encouraged.

**Submission and Publication**

Submit your full paper at m2vip@pub.seu.edu.cn or xswang@seu.edu.cn that is open now till the deadline. All the papers presented at the conference will be published in DVD proceedings that will be published in IEEE Xplore, indexed by EI. Moreover, a majority of the papers presented, subject to authors’ permission, will be published in International Journal of Intelligent Systems Technologies and Applications (IJISTA) and International Journal of Biomechatronics and Biomedical Robotics (IJBBR), Inderscience Publishers, UK, indexed in Computer and Information Systems, DBLP Computer Science Bibliography, Google Scholar, Inspet and Pascal (and SCI in process).

**Important Dates**

- Conference date: November 28-30, 2016
- Deadline of paper submission: July 20, 2016
- Acceptance notification: September 20, 2016
- Final paper submission: October 20, 2016
- Journal publication(Selected papers): Middle of 2017
Technical Program Committee Members

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Ming Zuo, University of Alberta, Canada
Koren Ward, University of Wollongong, Australia
Karsten Hoehn, CSIRO Mineral Resources Business Unit, Australia

Map of NanJing

CRH: China Railway Highspeed